

High Performance 1A LDO

ISL80101-ADJ

The ISL80101-ADJ is a low voltage, high current, single output LDO specified at 1A output current. This LDO operates from input voltages from 2.2V to 6V, and is capable of providing output voltages from 0.8V to 5V. The ISL80101-ADJ features an adjustable output. For the fixed output version of the ISL80101, please refer to the ISL80101 datasheet.

A submicron BiCMOS process is utilized for this product family to deliver the best in class analog performance and overall value. This CMOS LDO will consume significantly lower quiescent current as a function of load compared to bipolar LDOs, which translates into higher efficiency and packages with smaller footprints. State of the art internal compensation achieves a very fast load transient response. An external capacitor on the soft-start pin provides an adjustable soft-starting ramp. The ENABLE feature allows the part to be placed into a low quiescent current shutdown mode. A Power-good logic output signals a fault condition.

Table 1 shows the differences between the ISL80101-ADJ and others in its family:

TABLE 1. KEY DIFFERENCES BETWEEN FAMILY OF PARTS

| PART NUMBER | PROGRAMMABLE ILIMIT | I _{LIMIT} (DEFAULT) | ADJ OR FIXED V _{OUT} |
|--------------|---------------------|---------------------------------|----------------------------------|
| ISL80101-ADJ | No | 1.75A | ADJ |
| ISL80101 | No | 1.75A | 1.8V, 2.5V, 3.3V, 5.0V |
| ISL80101A | Yes | 1.62A | ADJ |
| ISL80121-5 | Yes | 0.75A | 5.0V |

Features

- ±0.2% initial V_{OUT} accuracy
- ±1.8% V_{OUT} accuracy guaranteed over line, load and T_I = -40 °C to +125 °C
- Very low 130mV dropout voltage at V_{OUT} = 2.5V
- · Very fast transient response
- · Programmable soft-starting
- · Power-good output
- · Excellent 58dB PSRR at 1kHz
- · Current limit protection
- · Thermal shutdown function
- · Available in a 10 Ld DFN package
- · Pb-Free (RoHS compliant)

Applications

- DSP, FPGA and µP core power supplies
- · Noise-sensitive instrumentation systems
- · Post regulation of switched mode power supplies
- · Industrial systems
- · Medical equipment
- · Telecommunications and networking equipment
- Servers
- Hard disk drives (HD/HDD)

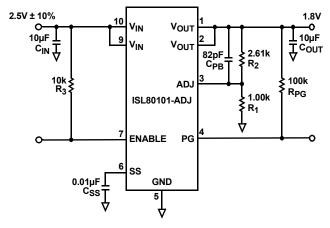


FIGURE 1. TYPICAL APPLICATION CIRCUIT

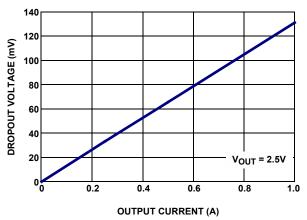
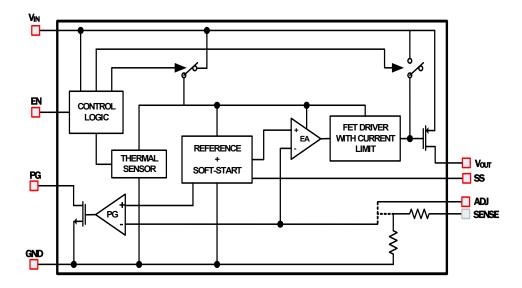


FIGURE 2. DROPOUT vs LOAD CURRENT

Block Diagram



Ordering Information

| PART NUMBER (Notes 3, 4) | PART MARKING | V _{OUT} VOLTAGE (<u>Note 2</u>) | TEMP RANGE (°C) | PACKAGE (Pb-Free) | PKG DWG. # |
|--------------------------|------------------|---|-----------------|----------------------|------------|
| ISL80101IRAJZ (Note 1) | DZAB | ADJ | -40 to +125 | 10 Ld 3x3 DFN | L10.3x3 |
| ISL80101EVAL2Z | Evaluation Board | | | | |

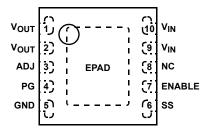
NOTES:

- 1. Add "-T*" for Tape and Reel. Please refer to TB347 for details on reel specifications.
- 2. For other output voltages, contact Intersil Marketing.
- 3. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 4. For Moisture Sensitivity Level (MSL), please see device information page for <u>ISL80101-ADJ</u>. For more information on MSL please see techbrief <u>TB363</u>.

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Pin Configurations

ISL80101-ADJ (10 LD 3x3 DFN) TOP VIEW



Pin Descriptions

| PIN NUMBER | PIN NAME | DESCRIPTION |
|------------|------------------|--|
| 1, 2 | V _{OUT} | Regulated output voltage. A minimum 10µF X5R/X7R output capacitor is required for stability. See <u>"External Capacitor Requirements" on page 8</u> for more details. |
| 3 | ADJ | This pin is connected to the feedback resistor divider and provides voltage feedback signals for the LDO to set the output voltage. In addition, the PGOOD circuit uses this input to monitor the output voltage status. |
| 4 | PG | This is an open-drain logic output used to indicate the status of the output voltage. Logic low indicates V _{OUT} is not in regulation. Must be grounded if not used. |
| 5 | GND | Ground |
| 6 | SS | External capacitor on this pin adjusts start-up ramp and controls inrush current. |
| 7 | ENABLE | V _{IN} independent chip enable. TTL and CMOS compatible. |
| 8 | NC | No connection; Leave floating. |
| 9, 10 | V _{IN} | Input supply; A minimum of 10µF X5R/X7R input capacitor is required for proper operation. See <u>"External Capacitor Requirements" on page 8</u> for more details. |
| - | EPAD | EPAD at ground potential. It is recommended to solder the EPAD to the ground plane. |

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Absolute Maximum Ratings

| V _{IN} Relative to GND (<u>Note 5</u>)0.3V to +6.5V |
|---|
| V _{OUT} Relative to GND (Note 5) |
| PG, ENABLE, ADJ, SS |
| Relative to GND (Note 5) |
| ESD Rating |
| Human Body Model (Tested per JESD22 A114F)2.5kV |
| Machine Model (Tested per JESD22 A115C) 250V |
| Latch-Un (Tested per IESD78C, Class 2, Level Δ) +100mΔ at +85°C |

Thermal Information

| Thermal Resistance (Typical) | $\theta_{JA}(^{\circC/W})$ | θ_{JC} (°C/W) |
|--------------------------------|----------------------------|----------------------|
| 10 Ld DFN Package (Notes 6, 7) | 48 | 7 |
| Storage Temperature Range | 6! | 5°C to +150°C |
| Junction Temperature | | +150°C |
| Pb-Free Reflow Profile | | see TB493 |

Recommended Operating Conditions (Notes 8, 9)

| Junction Temperature Range (TJ) (Note 8) | 40°C to +125°C |
|---|----------------|
| V _{IN} Relative to GND | 2.2V to 6V |
| V _{OUT} Range | 800mV to 5V |
| PG, ENABLE, SENSE/ADJ, SS relative to GND . | 0V to 6V |
| PG Sink Current | <10mA |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- 5. ABS max voltage rating is defined as the voltage applied for a lifetime average duty cycle above 6V of 1%.
- θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379.
- 7. For θ_{JC} , the "case temp" location is the center of the exposed metal pad on the package underside.
- 8. Extended operation at these conditions may compromise reliability. Exceeding these limits will result in damage. Recommended operating conditions define limits where specifications are guaranteed.
- 9. Electromigration specification defined as lifetime average junction temperature of +110°C where max rated DC current = lifetime average current.

Electrical Specifications Unless otherwise noted, $V_{IN} = V_{OUT} + 0.4V$, $V_{OUT} = 1.8V$, $C_{IN} = C_{OUT} = 2.2\mu F$, $T_J = +25^{\circ} C$. Applications must follow thermal guidelines of the package to determine worst case junction temperature. Please refer to "Applications Information" on page 8 and Tech Brief TB379. Boldface limits apply across the operating temperature range, -40°C to +125°C.

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN (<u>Note 10</u>) | TYP | MAX (Note 10) | UNITS |
|--|--|---|---------------------------|------|------------------|-------------------|
| DC CHARACTERISTICS | | | | | | |
| Feedback Pin (ADJ Option Only) | V _{ADJ} | 2.2 V \leq V $_{IN}$ \leq 6V, 0A $<$ I $_{LOAD}$ $<$ 1A | 491 | 500 | 509 | m۷ |
| DC Input Line Regulation | ΔV _{OUT} / ΔV _{IN} | V _{OUT} + 0.5V < V _{IN} < 5V | | | 1 | % |
| DC Output Load Regulation | ∆V _{OUT} / ∆l _{OUT} | 0A < I _{LOAD} < 1A, All voltage options | -1 | | | % |
| Feedback Input Current | | V _{ADJ} = 0.5V | | 0.01 | 1 | μΑ |
| Ground Pin Current | ΙQ | I _{LOAD} = 0A, 2.2V < V _{IN} < 6V | | 3 | 5 | mA |
| | | I _{LOAD} = 1A, 2.2V < V _{IN} < 6V | | 5 | 7 | mA |
| Ground Pin Current in Shutdown | I _{SHDN} | ENABLE Pin = 0.2V, V _{IN} = 6V | | 0.2 | 12 | μΑ |
| Dropout Voltage (<u>Note 11</u>) | V _{DO} | I _{LOAD} = 1A, V _{OUT} = 2.5V | | 130 | 212 | mV |
| Output Short Circuit Current | ОСР | V _{OUT} = 0V, 2.2V < V _{IN} < 6V | | 1.75 | | Α |
| Thermal Shutdown Temperature | TSD | 2.2V < V _{IN} < 6V | | 160 | | °C |
| Thermal Shutdown Hysteresis (Rising Threshold) | TSDn | 2.2V < V _{IN} < 6V | | 30 | | °C |
| AC CHARACTERISTICS | | | " | | 1 | I |
| Input Supply Ripple Rejection | PSRR | f = 1kHz, I _{LOAD} = 1A; V _{IN} = 2.2V | | 58 | | dB |
| | | f = 120Hz, I _{LOAD} = 1A; V _{IN} = 2.2V | | 72 | | dB |
| Output Noise Voltage | | I _{LOAD} = 1A, BW = 10Hz < f < 100kHz | | 63 | | μV _{RMS} |

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Electrical Specifications Unless otherwise noted, $V_{IN} = V_{OUT} + 0.4V$, $V_{OUT} = 1.8V$, $C_{IN} = C_{OUT} = 2.2\mu$ F, $T_J = +25$ °C. Applications must follow thermal guidelines of the package to determine worst case junction temperature. Please refer to "Applications Information" on page 8 and Tech Brief TB379. Boldface limits apply across the operating temperature range, -40°C to +125°C. (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN (<u>Note 10</u>) | TYP | MAX (Note 10) | UNITS |
|-------------------------------------|--------|---|---------------------------|-----|------------------|-------------------|
| ENABLE PIN CHARACTERISTICS | " | | • | | | 1 |
| Turn-on Threshold | | 2.2V < V _{IN} < 6V | 0.3 | 0.8 | 1 | V |
| Hysteresis (Rising Threshold) | | 2.2V < V _{OUT} + 0.4V < 6V | 10 | 80 | 200 | mV |
| ENABLE Pin Turn-on Delay | | C _{OUT} = 10μF, I _{LOAD} = 1A | | 100 | | μs |
| ENABLE Pin Leakage Current | | V _{IN} = 6V, ENABLE = 3V | | | 1 | μΑ |
| SOFT-START CHARACTERISTICS | 1 | | , | | II. | 1 |
| SS Pin Currents (Note 12) | IPD | V _{IN} = 3.5V, ENABLE = 0V, SS = 1V | 0.5 | 1 | 1.3 | mA |
| | ICHG | | -3.3 | -2 | -0.8 | μΑ |
| PG PIN CHARACTERISTICS | 1 | | 1 | | l | I |
| V _{OUT} PG Flag Threshold | | | 75 | 85 | 92 | %V _{OUT} |
| V _{OUT} PG Flag Hysteresis | | | | 4 | | % |
| PG Flag Low Voltage | | V _{IN} = 2.5V, I _{SINK} = 500μA | | | 100 | mV |
| PG Flag Leakage Current | | V _{IN} = 6V, PG = 6V | | | 1 | μΑ |

NOTES:

- 10. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
- $\textbf{11.} \ \ \, \text{Dropout is defined as the difference in supply V}_{\text{IN}} \ \text{and V}_{\text{OUT}} \ \text{when the supply produces a 2\% drop in V}_{\text{OUT}} \ \text{from its nominal voltage}.$
- 12. I_{PD} is the internal pull down current that discharges the external SS capacitor on disable. I_{CHG} is the current from the SS pin that charges the external SS capacitor during start-up.

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Typical Operating Performance

Unless otherwise noted: V_{IN} = 2.2V, V_{OUT} = 1.8V, C_{IN} = C_{OUT} = 10 μ F, T_J = +25 °C, I_L = 0A.

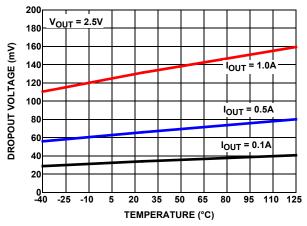


FIGURE 3. DROPOUT vs TEMPERATURE

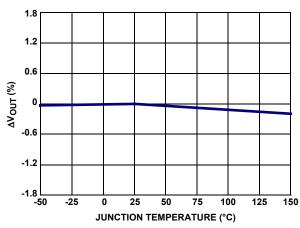


FIGURE 4. V_{OUT} vs TEMPERATURE

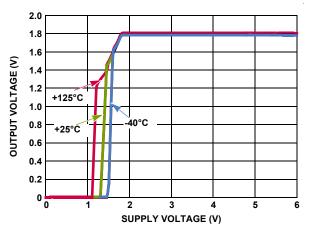


FIGURE 5. OUTPUT VOLTAGE vs SUPPLY VOLTAGE

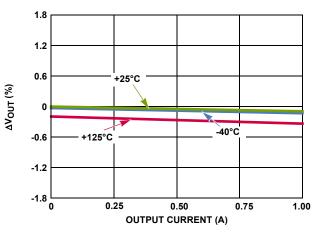


FIGURE 6. OUTPUT VOLTAGE vs OUTPUT CURRENT

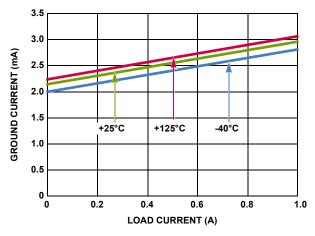


FIGURE 7. GROUND CURRENT vs LOAD CURRENT

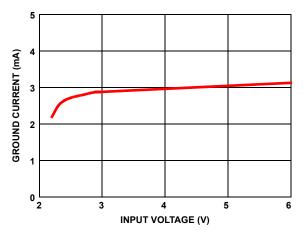


FIGURE 8. GROUND CURRENT vs SUPPLY VOLTAGE

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Typical Operating Performance

Unless otherwise noted: V_{IN} = 2.2V, V_{OUT} = 1.8V, C_{IN} = C_{OUT} = 10 μ F, T_J = +25 °C, I_L = 0A. (Continued)

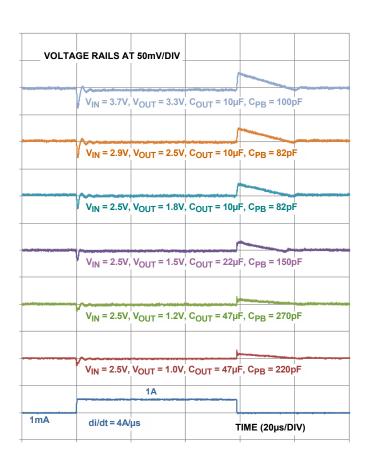


FIGURE 9. LOAD TRANSIENT RESPONSE

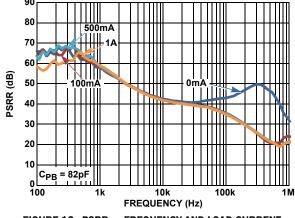


FIGURE 12. PSRR vs FREQUENCY AND LOAD CURRENT

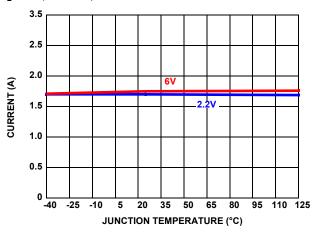


FIGURE 10. CURRENT LIMIT vs TEMPERATURE (V_{OUT} = 0V)

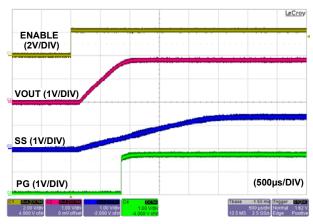


FIGURE 11. ENABLE START-UP (C_{SS} = 2.2nF)

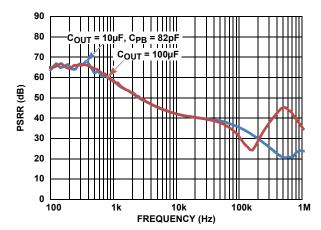


FIGURE 13. PSRR vs FREQUENCY AND OUTPUT CAPACITANCE (I_{OUT} = 100mA)

Typical Operating Performance

Unless otherwise noted: V_{IN} = 2.2V, V_{OUT} = 1.8V, C_{IN} = C_{OUT} = 10 μ F, T_J = +25°C, I_L = 0A. (Continued)

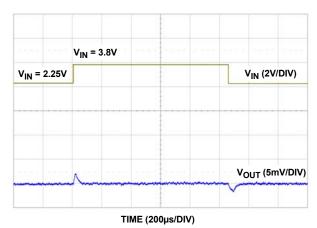


FIGURE 14. LINE TRANSIENT RESPONSE

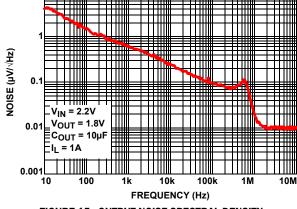


FIGURE 15. OUTPUT NOISE SPECTRAL DENSITY

Applications Information

Input Voltage Requirements

ISL80101-ADJ is capable of delivering output voltages from 0.8V to 5.0V. Due to the nature of an LDO, $V_{\mbox{\footnotesize{IN}}}$ must be some margin higher than V_{OUT} plus dropout at the maximum rated current of the application if active filtering (PSRR) is expected from VIN to V_{OUT}. The very low dropout specification of this family of LDOs allows applications to design for a level of efficiency that can accommodate profiles smaller than the T0220/263.

Enable Operation

The Enable turn-on threshold is typically 800mV with 80mV of hysteresis. This pin must not be left floating, and should be tied to V_{IN} if not used. A $1k\Omega$ to $10k\Omega$ pull-up resistor is required for applications that use open collector or open-drain outputs to control the Enable pin. An internal pull-up or pull-down resistor to change these values is available upon request. The Enable pin may be connected directly to V_{IN} for applications with outputs that are always on.

Power-Good Operation

PG is a logic output that indicates the status of $V_{\mbox{OUT}}$. The PG flag is an open-drain NMOS that can sink up to 10mA. It requires an external pull-up resistor typically connected to the V_{OUT} pin. The PG pin should not be pulled up to a voltage source greater than V_{IN}. PG goes low when the output voltage drops below 84% of the nominal output voltage or if the part is disabled. The PG comparator functions during current limit and thermal shutdown. For applications not using this feature, connect this pin to ground.

Soft-Start Operation

The soft-start circuit controls the rate at which the output voltage rises up to regulation at power-up or LDO enable. This start-up ramp time can be set by adding an external capacitor from the SS pin to ground. An internal 2µA current source charges up this CSS and the feedback reference voltage is clamped to the voltage across it. The start-up time is set by Equation 1.

$$\textbf{T}_{\text{start}} = \frac{c_{\text{SS}} x 0.5}{2 \mu \text{A}} \tag{EQ. 1}$$

Equation 2 determines the C_{SS} required for a specific start-up in-rush current, where $\mathbf{V}_{\mbox{OUT}}$ is the output voltage, $\mathbf{C}_{\mbox{OUT}}$ is the total capacitance on the output and I_{INRUSH} is the desired in-rush

$$c_{SS} = \frac{v_{OUT}^{ x} c_{OUT}^{ x} 2\mu A}{I_{INRUSH}^{ x} 0.5 V} \tag{EQ. 2}$$

The external capacitor is always discharged to ground at the beginning of start-up or enabling.

Output Voltage Selection

An external resistor divider, R₁ and R₂ as referenced in Figure 1 on page 1, is used to scale the output voltage relative to the internal reference voltage. The output voltage can be programmed to any level between 0.8V and 5V. The recommended value for R_2 is 500Ω to $5k\Omega$. R_1 is then chosen to satisfy Equation 3.

$$V_{OUT} = 0.5V \times \left(\frac{R_2}{R_1} + 1\right)$$
 (EQ. 3)

External Capacitor Requirements

External capacitors are required for proper operation. Careful attention must be paid to the layout guidelines and selection of capacitor type and value to ensure optimal performance.

OUTPUT CAPACITOR

The ISL80101-ADJ applies state-of-the-art internal compensation to keep the selection of the output capacitor simple for the customer. Stable operation over full temperature, VIN range, V_{OUT} range and load extremes are guaranteed for all capacitor types and values assuming the minimum recommended ceramic capacitor is used for local bypass on Vour. There is a growing trend to use very-low ESR multilayer ceramic capacitors (MLCC) because they can support fast load transients and also bypass very high frequency noise from other sources. However, the effective capacitance of MLCCs drops with applied voltage, age,

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and temperature. X7R and X5R dieletric ceramic capacitors are strongly recommended as they typically maintain a capacitance range within ±20% of nominal voltage over full operating ratings of temperature and voltage. This output capacitor must be connected to the V_{OUT} and GND pins of the LDO with PCB traces no longer than 0.5cm.

Additional capacitors of any value in ceramic, POSCAP, alum/tantalum electrolytic types may be placed in parallel to improve PSRR at higher frequencies and/or load transient AC output voltage tolerances. The use of CPB (see following section) is recommended when only the minimum recommended ceramic capacitor is used on the output. Please refer to Table 2 for these minimum conditions for various output voltages.

Phase Boost Capacitor

A small phase boost capacitor, CPB, can be placed across the top resistor, R2, in the feedback resistor divider network in order to place a zero at:

$$\textbf{F}_{z} = \frac{1}{2\pi x \textbf{R}_{2} x \textbf{C}_{\textbf{PB}}} \tag{EQ. 4}$$

This zero increases the crossover frequency of the LDO and provides additional phase resulting in faster load transient response.

It is important to note that LDO stability and load transient performance are affected by the type of output capacitor used. For optimal result, empirical tuning of CPB is suggested for each specific application. It is recommended to not use C_{PB} when high ESR capacitors such as Aluminum Electrolytic or Tantalum are used on the output.

Table 2 shows the recommended minimum ceramic COLIT and corresponding CPB, R2 and R1 for different output voltages.

TABLE 2. RECOMMENDED $C_{\mbox{\scriptsize PB}}$ FOR DIFFERENT $V_{\mbox{\scriptsize OUT}}$ AND $C_{\mbox{\scriptsize OUT}}$

| V _{OUT} (V) | R ₂ (kΩ) | R ₁ (kΩ) | C _{OUT} (μ F) | C _{PB} (pF) |
|----------------------|------------------------|------------------------|-----------------------------------|-------------------------|
| 5.0 | 2.61 | 0.287 | 10 | 100 |
| 3.3 | 2.61 | 0.464 | 10 | 100 |
| 2.5 | 2.61 | 0.649 | 10 | 82 |
| 1.8 | 2.61 | 1.0 | 10 | 82 |
| 1.5 | 2.61 | 1.3 | 10 | 68 |
| 1.5 | 2.61 | 1.3 | 22 | 150 |
| 1.2 | 2.61 | 1.87 | 22 | 120 |
| 1.2 | 2.61 | 1.87 | 47 | 270 |
| 1.0 | 2.61 | 2.61 | 47 | 220 |
| 0.8 | 2.61 | 4.32 | 47 | 220 |

INPUT CAPACITOR

For proper operation, a minimum capacitance of 10µF X5R/X7R is required at the input. This ceramic input capacitor must be connected to the V_{IN} and GND pins of the LDO with PCB traces no longer than 0.5cm.

Power Dissipation and Thermals

The junction temperature must not exceed the range specified in the "Recommended Operating Conditions (Notes 8, 9)" on page 4. The power dissipation can be calculated by using Equation 5:

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$
 (EQ. 5)

The maximum allowable junction temperature, $T_{J(MAX)}$ and the maximum expected ambient temperature, TA(MAX) determine the maximum allowable power dissipation, as shown in Equation 6:

$$P_{D(MAX)} = (T_{J(MAX)} - T_{A})/\theta_{JA}$$
 (EQ. 6)

 $\theta_{\,\text{IA}}$ is the junction-to-ambient thermal resistance.

For safe operation, enure that the power dissipation PD, calculated from Equation 5, is less than the maximum allowable power dissipation $P_{D(MAX)}$.

The DFN package uses the copper area on the PCB as a heatsink. The EPAD of this package must be soldered to the copper plane (GND plane) for effective heat dissipation. Figure 16 shows a curve for the θ_{JA} of the DFN package for different copper area sizes.

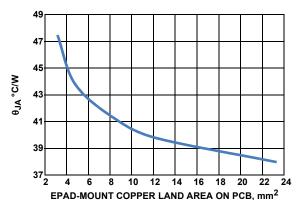


FIGURE 16. 3mmx3mm 10-PIN DFN ON 4-LAYER PCB WITH THERMAL VIAS θ_{JA} vs EPAD-MOUNT COPPER LAND **AREA ON PCB**

Thermal Fault Protection

The power level and the thermal impedance of the package (+45°C/W for DFN) determine when the junction temperature exceeds the thermal shutdown temperature. In the event that the die temperature exceeds around +160°C, the output of the LDO will shut down until the die temperature cools down to about +130°C.

Current Limit Protection

The ISL80101-ADJ LDO incorporates protection against overcurrent due to any short or overload condition applied to the output pin. The LDO performs as a constant current source when the output current exceeds the current limit threshold noted in the "Electrical Specifications" table on page 4. If the short or overload condition is removed from VOLIT, then the output returns to normal voltage regulation mode. In the event of an overload condition, the LDO may begin to cycle on and off due to the die temperature exceeding thermal fault condition and subsequently cooling down after the power device is turned off.

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ISL80101-ADJ

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

| DATE | REVISION | CHANGE |
|----------------|----------|--|
| July 31, 2014 | FN7834.2 | Updated the "Block Diagram" on page 2 reversed the + and - terminals on the EA amp. The non-inverting terminal is now connected to the Adj/Sense pin. Updated About Intersil verbiage to new standard. Updated "Package Outline Drawing" on page 11 to latest revision. |
| August 3, 2011 | FN7834.1 | PAGE 1 1. Introduction, paragraph 1: Last two sentences removed, and replaced with: "The ISL80101-ADJ features an adjustable output. For the fixed output version of the ISL80101, please refer to the ISL80101 datasheet." 2. Table 1: Replaced Table 1 with Table 1 from FN6931 to include the "ADJ or Fixed VOUT" column and "ISL80101-ADJ" row. 3. Features: "Available in a 10 Ld DFN Package" has "T0220-5, T0263-5 and S0T223-5 to follow soon" removed. PAGE 5 1. Enable Pin Characteristics a. "Enable Pin Turn-on Delay" changed to "ENABLE Pin Turn-on Delay" b. "Enable Pin Leakage Current" changed to "ENABLE Pin Leakage Current" PAGE 7 Figure 9: Timescale changed from "20μs/DIV" to "TIME (20μs/DIV)" PAGE 8 2. Equation 1 - Parentheses deleted. 3. Equation 2 - Parentheses deleted. |
| March 31, 2011 | FN7834.0 | Initial Release. |

About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at www.intersil.com.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.

Reliability reports are also available from our website at www.intersil.com/support.

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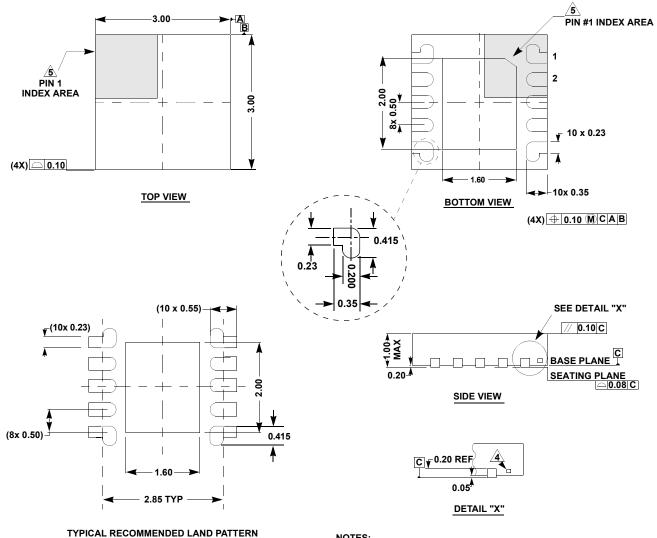
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Package Outline Drawing

L10.3x3

10 LEAD DUAL FLAT PACKAGE (DFN) Rev 10, 7/14



NOTES:

- 1. Dimensions are in millimeters. Dimensions in () for Reference Only.
- Dimensioning and tolerancing conform to ASME Y14.5m-1994.
- Unless otherwise specified, tolerance : Decimal ± 0.05
- Tiebar shown (if present) is a non-functional feature.
- 5. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

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